	- 03-25-199	00		
FORM PTO-1595 (Rev. 6-93) OMB No. 0651-0011 (exp. 4/94)		ED CHEET U.S. DEPARTMENT OF COMMERCE		
Tab settings □ □ □ ▼	100677202			
	er of Patents and Trademark	7777		
Name of conveying party(ies):	Hiroki Ogato Toru Akazawa Akihisa Ono Satoshi Shinohara	2. Name and address of receiving party(es) Name: Sony Computer Entertainment Inc		
Additional name(s) of conveying party(ies)		Internal Address:		
3. Nature of conveyance: MRD 3-33-98				
Assignment	☐ Merger	Street Address: 1-22, Akasaka 8-Chome,		
☐ Security Agreement	☐ Change of Name	Minato-ku		
☐ Other		City: Tokyo State: Japan ZIP:		
Execution Date: January 20, 1998		Additional name(s) & address(es) attached? ☐ Yes ☑ No		
4. Application number(s) or patent	t number(s):	·		
If this document is being filed to	ogether with a new application	n, the execution date of the application is:		
A. Patent Application No.(s)		B. Patent No.(s)		
08/940,238		• • • • • • • • • • • • • • • • • • •		
•	Additional numbers att	ached? ☐ Yes XIXNo		
Name and address of party to whom correspondence concerning document should be mailed:		6. Total number of applications and patents involved: 1		
Name: Gilbert G. Ko	velman, Esq.	7. Total fee (37 CFR 3.41)\$ 40.00		
Internal Address: Fulwider Patton Lee &		☑ Enclosed		
Utecht, LLP		D. Authorized to be abound to deposit execute		
10th Floor		□ Authorized to be charged to deposit account		
Street Address: 10877 Wi	lshire Boulevard	8. Deposit account number:		
City: Los Angeles State	: <u>CA</u> ZIP: 90024	(Attach duplicate copy of this page if paying by deposit account)		
DO NOT USE THIS SPACE				
9. Statement and signature. To the best of my knowledge ar the original document. Gilbert G. Kovelman Name of Person Signing	(Alf B	ation is true and correct and any attaches copy is a true copy of March 19, 1998 Signature		
INATION OF PERSON SIGNING	•	cover sheet, attachments, and document:		
		7		

Docket Number: <u>\$97P1246US00</u> 45115/SONYP

ASSIGNMENT

WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in GAME MACHINE CONTROL MODULE AND GAME MACHINE

for which application for Letters Patent of the United States of America was executed by me on the date indicated next to my name and address;

AND WHEREAS, Sony Computer Entertainment Inc., a Japanese corporation with offices at 1-22, Akasaka 8-Chome, Minato-ku, Tokyo Japan (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invention, said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be granted therefor in the United States and in any and all foreign countries;

NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents do hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letters Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of America adheres, and to any other benefits accruing or to accrue to me with respect to the filing of applications for patents or securing of patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;

And I further agree to execute all necessary or desirable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to me and without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention, applications and Letters Patent of the United States and countries foreign thereto;

And I further agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawful papers for application for foreign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue or reissues of any Letters Patent which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require and prepare at its own expense;

And I further agree that ASSIGNEE will, upon its request, be provided promptly with all pertinent facts and documents relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known and accessible to me and will testify as to the same in any interference or litigation related thereto;

And I hereby covenant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.

And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number: 08/940,238, Filing Date: September 30, 1997.

This assignment executed on the dates indicated below.

Hiroki Ogato		famuary.	20 1995
Name of first or sole inventor	•	Execution date	of U.S. Patent Application
Chiba, Japan			
Residence of first or sole inventor			
H canta.		I annary.	20, 1958
Signature of first or sole inventor			Date of this assignment

Page 1 of 2

Docket No.: <u>S97P1246US00</u> 45115/SONYP

Toru Akazawa	Execution date of U.S. Patent application
Name of second joint inventor	Execution date of U.S. Patent application
Tokyo, Japan Residence of second joint inventor	
Residence of second joint inventor	
Signature of second joint inventor	Janualy, 20. 1996 Date of this Assignment
Signature of second joint inventor	Date of this Assignment
	7.9c (c
Akihisa Ono	Execution date of U.S. Patent application
Name of third joint inventor	Execution date of U.S. Patent application
Tokyo, Japan	
Residence of third joint inventor	
Signature of third joint inventor	Date of this Assignment
Signature of third joint inventor	Date of this Assignment
Carra 11 Cl t al ann	Ta april 21 1998
Satoshi Shinohara Name of fourth joint inventor	Execution date of U.S. Patent application
Name of fourth joint inventor	insection date of o.b. ratent apprication
Tokyo, Japan	
Residence of fourth joint inventor	
Signature of fourth joint inventor	Temwary 21 /998 Date of this Assignment
Signature of fourth joint inventor	/ Date of this Assignment